2SC4638

Silicon NPN triple diffusion planar type

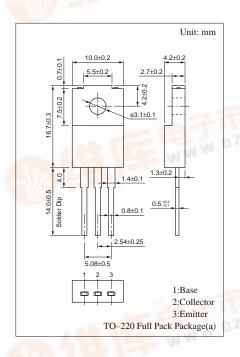
For high breakdown voltage high-speed switching

Features

- High-speed switching
- High collector to base voltage V_{CBO}
- Low collector to emitter saturation voltage V_{CE(sat)}
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings (T_C=25°C)

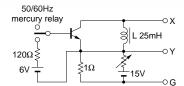
Parameter	Symbol	Ratings	Unit	
Collector to base voltage	V _{CBO}	800	V	
C-11	V _{CES}	800	V	
Collector to emitter voltage	V _{CEO}	500	V	
Emitter to base voltage	$V_{\rm EBO}$	8	V	
Peak collector current	I_{CP}	10	A	
Collector current	I_C	5	A	
Base current	I_B	3	A	
Collector power T _C =25°C	D.	40	W	
dissipation Ta=25°C	P_{C}	2		
Junction temperature	T _j	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



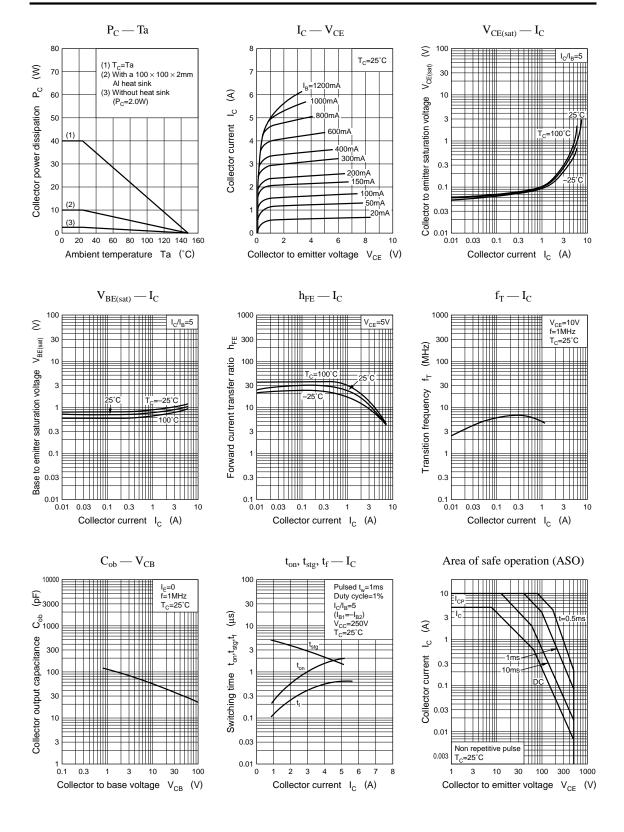
Electrical Characteristics (T_C=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 800V, I_E = 0$			100	μА
Emitter cutoff current	I_{EBO}	$V_{EB} = 5V, I_{C} = 0$			100	μΑ
Collector to emitter voltage	V _{CEO(sus)} *	$I_C = 0.2A, L = 25mH$	500		- 44	V
Forward current transfer ratio	h _{FE1}	$V_{CE} = 5V, I_{C} = 0.1A$	15		-	
	h _{FE2}	$V_{CE} = 5V, I_C = 3A$	8			
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 3A, I_B = 0.6A$			1	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_C = 3A, I_B = 0.6A$			1.5	V
Transition frequency	f_{T}	$V_{CE} = 10V, I_{C} = 0.5A, f = 1MHz$		8		MHz
Turn-on time	t _{on}	1 24 1 064 1 064			1.0	μs
Storage time	t _{stg}	$I_C = 3A$, $I_{B1} = 0.6A$, $I_{B2} = -0.6A$,			3	μs
Fall time	$t_{\rm f}$	$V_{CC} = 200V$			1.0	μs



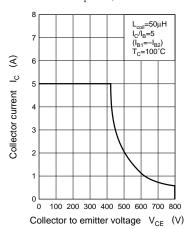


Power Transistors 2SC4638

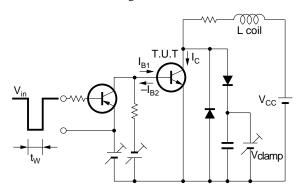


Power Transistors 2SC4638

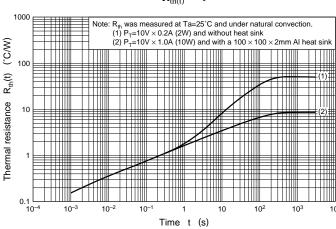
Area of safe operation, reverse bias ASO



Reverse bias ASO measuring circuit



 $R_{th(t)} -\!\!\!- t$



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